

# ACE110N50LA N-channel Enhanced MOSFETs

#### Description

ACE110N50LA, the silicon N-channel Enhanced MOSFETs, is obtained by advanced MOSFET technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor is suitable device for SMPS, high speed switching and general-purpose applications. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.

#### Features

- $V_{DS} @T_J = 500V(Max), I_D = 8A, R_{DS(ON)} = 1.0\Omega (Typ)$
- Fast Switching
- 100% avalanche tested
- Low Crss
- Improved dv/dt capability

### Applications

- Electronic ballast
- High frequency switching mode power supply

#### **Absolute Maximum Ratings** (T<sub>c</sub>=25°C Unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-to-Source Voltage	$V_{DSS}$	500	V
Continuous Drain Current	I	8	А
Continuous Drain Current T <sub>c</sub> = 100 °C	I <sub>D</sub>	5	А
Pulsed Drain Current (Note1)	I <sub>DM</sub>	30	А
Gate-to-Source Voltage	$V_{GS}$	±30	V
Single Pulse Avalanche Energy (Note2)	E <sub>AS</sub>	520	mJ
Peak Diode Recovery dv/dt (Note3)	dv/dt	5.0	V/ns
Power Dissipation TO-220/ TO-251/ TO-252	PD	160	W
Derating Factor above 25°C		1.28	W/°C
Power Dissipation TO-220F		48	W
Derating Factor above 25°C		0.38	W/°C
Operating Junction and Storage Temperature Range	$T_J$ , $T_stg$	150, -55 to 150	°C
Maximum Temperature for Soldering	ΤL	300	°C

1. Pulse width limited by maximum junction temperature

2. L=20mH, VDs=50V, R\_G=25 $\Omega$ , Start TJ=25 $^{\circ}$ C

3. ISD =8A,di/dt ≤100A/us, VDD≤BVDS, Start TJ=25 $^{\circ}$ C



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Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.

### Thermal Characteristic

TO-220

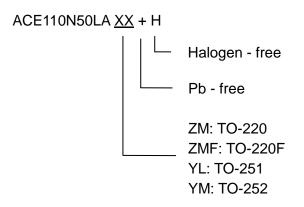
Parameter	Symbol	Rating	Unit
Junction-to-Case	$R_{ extsf{ heta}JC}$	0.78	°C/W
Junction-to-Ambient	$R_{ extsf{ heta}JA}$	62.5	

TO-220F

Parameter	Symbol	Rating	Unit
Junction-to-Case	$R_{ extsf{ heta}JC}$	2.6	°C/W
Junction-to-Ambient	R <sub>eja</sub>	62.5	



## **Ordering Information**





#### Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Technology Co., LTD. As sued herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and shoes failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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